

P-Channel Enhancement Mode Field Effect Transistor

General Description

The AO4437 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch or in PWM applications. It is ESD protected. Standard Product AO4437 is Pb-free (meets ROHS & Sony 259 specifications). AO4437L is a Green Product ordering option. AO4437 and AO4437L are electrically identical.

Features

 $V_{DS}(V) = -12V$

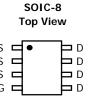
 $I_D = -11 \text{ A } (V_{GS} = -4.5 \text{V})$

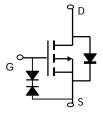
 $R_{DS(ON)}$ < 16m Ω (V_{GS} = -4.5V)

 $R_{DS(ON)}$ < 20m Ω (V_{GS} = -2.5V)

 $R_{DS(ON)}$ < 25m Ω (V_{GS} = -1.8V)

ESD Rating: 4KV HBM





Absolute Maximum Ratings T _A =25°C unless otherwise noted								
Parameter		Symbol	Maximum	Units				
Drain-Source Voltage		V_{DS}	-12	V				
Gate-Source Voltage		V_{GS}	±8	V				
Continuous Drain	T _A =25°C		-11					
Current ^A	T _A =70°C	I _D	-9	A				
Pulsed Drain Current ^B		I _{DM}	-20	1				
	T _A =25°C	D	3	w				
Power Dissipation ^A	T _A =70°C	$-P_D$	2.1					
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C				

Thermal Characteristics									
Parameter	Symbol	Тур	Max	Units					
Maximum Junction-to-Ambient A	t ≤ 10s	В	31	40	°C/W				
Maximum Junction-to-Ambient A	Steady-State R _{0JA}		63	75	°C/W				
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	21	30	°C/W				

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC F	PARAMETERS					
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =-250μA, V _{GS} =0V				V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-9.6V, V _{GS} =0V			-1	μА
		T _J =55°C	С		-5	
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±4.5V			±1	μА
		V_{DS} =0V, V_{GS} =±8V			±10	μА
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=-250\mu A$		-0.55	-1	
$I_{D(ON)}$	On state drain current	V _{GS} =-4.5V, V _{DS} =-5V	-20			Α
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =-4.5V, I _D =-11A		12.4	16	mΩ
		T _J =125°	С	17	21	
		V_{GS} =-2.5V, I_{D} =-10A		15.9	20	mΩ
		V _{GS} =-1.8V, I _D =-6A		20.4	25	mΩ
g _{FS}	Forward Transconductance	ce V_{DS} =-5V, I_D =-11A		38		S
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V		-0.74	-1	V
Is	Maximum Body-Diode Continuous Current				-4.5	Α
DYNAMIC	PARAMETERS					
C _{iss}	Input Capacitance			3960	4750	pF
Coss	Output Capacitance	V_{GS} =0V, V_{DS} =-6V, f=1MHz		910		pF
C_{rss}	Reverse Transfer Capacitance			757		pF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		6.9	8.5	Ω
SWITCHI	NG PARAMETERS					
Q_g	Total Gate Charge			37	47	nC
Q_{gs}	Gate Source Charge	V_{GS} =-4.5V, V_{DS} =-6V, I_{D} =-11A		4.5		nC
Q_{gd}	Gate Drain Charge			11		nC
$t_{D(on)}$	Turn-On Delay Time			15		ns
t _r	Turn-On Rise Time	V_{GS} =-4.5V, V_{DS} =-6V, R_L =0.55 Ω , R_{GEN} =3 Ω		43		ns
$t_{D(off)}$	Turn-Off Delay Time			158		ns
t _f	Turn-Off Fall Time			95		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-11A, dI/dt=100A/μs		64		ns
Q_{rr}	Body Diode Reverse Recovery Charge	, I _F =-11A, dI/dt=100A/μs		50		nC

A: The value of $R_{\theta,JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t≤ 10s thermal resistance rating.

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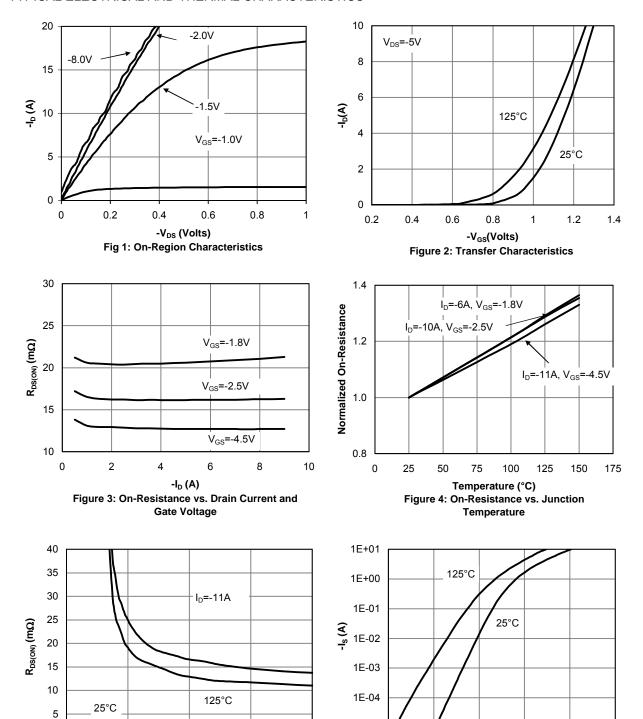
B: Repetitive rating, pulse width limited by junction temperature.

C. The $R_{\theta,IA}$ is the sum of the thermal impedence from junction to lead $R_{\theta,II}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6,12,14 are obtained using 80 µs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



1E-05

8

0.0

0.2

0.4

-V_{SD} (Volts)

Figure 6: Body-Diode Characteristics

0.6

8.0

1.0

-V_{GS} (Volts)
Figure 5: On-Resistance vs. Gate-Source Voltage

4

6

0

0

2